

Solid State Solutions for IoT Applications

Value-add SSD Technologies Overcome Embedded/Industrial Design Challenges

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- The Internet of Things (IoT)
- Common IoT Issues/Challenges
- The Essence of "Value"
- (Value-add) Solid State Storage for IoT
- Summary





Flash Memory The Internet of Things (IoT)

- Billions of "intelligent" devices deployed into global infrastructure by end of the decade
- Key challenges:
 - Compute footprint and power reqs will shrink
 - Ruggedness, reliability and endurance will rise
- Application-specific SSD solutions required to address challenges





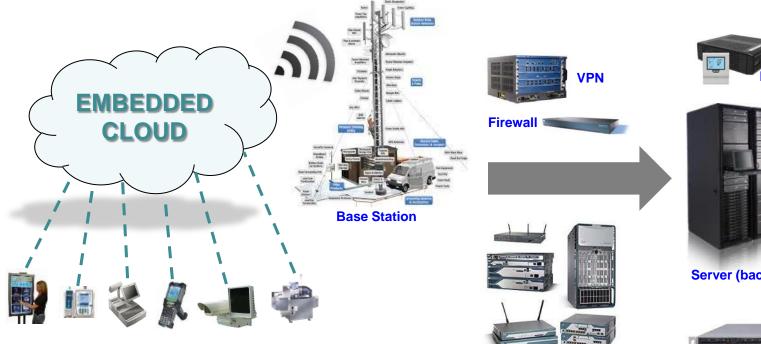






Infrastructure: "Feeding the Cloud"

Acquisition ➤ "Big Data" Analytics



Kiosk, Signage, Medical, POS, Terminal, Security, **Energy, Automation, Transportation**







Server (backup module)



Storage Appliance (boot)

------INFRASTRUCTURE ------





IoT Storage Requirements

| | Client | Enterprise | Data Center | IoT (Infrastructure) |
|-----------------------|--|---|---|---|
| Application | OS and user data | persistent back-end for DRAM or high perf. cache for tiered storage | OS and user data, dedicated server | OS and system data; single-source user data |
| Market driver | Read IOPS for instant-on, better user experience | R/W IOPS and low latency for 100's or 1000's of VM users | Build-your-own boxes (Google/Amazon, etc.) | Ruggedness, reliability, limited re-qualification |
| Main Interfaces | eMMC for tablets/phones SATA 6G → PCIe | SAS, PCle x8 or x16, mixed workloads | SATA 6G → PCIe | SATA 3G, 6G; USB 2.0, PATA/CF; PCIe just starting |
| Capacity | 128 GB to 1TB | 200GB to 1.6TB | 120GB to 1TB | 128MB to 512GB |
| Form factors | 2.5", mSATA → M.2, BGA | 2.5", PCIe card, rack appliances | 2.5" 7mm, mSATA → M.2 | All SATA, 10-pin eUSB, CF, SD |
| Endurance | < 20GB/day | 5-10 full drive writes per day | 3 full drive writes per day | Read only to 300GB per day |
| Years of operation | 2-3 years , 8 hours/day | 5 years , 24 hours/day | 3 years , 24 hours/day | 10 years , 24 hours/day |
| Operating temperature | 0° to 70° C | 0° to 60° C | 0° to 70° C | 0° to 70° C -40° to 85° C |





Flash Memory Common IoT Issues/Challenges

| Issue / Challenge | "Standard" SSDs | "Infrastructure" SSDs |
|---------------------------------------|--------------------------------------|---|
| Systems getting smaller | 2.5" SSD larger than some systems | 60%+ smaller than 2.5" SSD |
| Low power/heat reqs (green, no fans) | Typically 3+ watts (perf over power) | Typically under 2W (balance perf/power) |
| Extreme temps, humidity, shock/vib | Temps 0C/60C, controlled environment | Designed/tested to -40C/85C, ruggedized |
| 24x7 uptime with some power loss | Designed for "graceful" shutdown | Built-in power-fail protection |
| 5+ year uninterrupted performance | 1-2 year warranty, 1M hour MTBF | 3-5 year warranty, 2M+ hour MTBF |
| <64GB capacities with low budgets | 100GB+ min capacity (overkill) | 8GB – 512GB for high/low capacity needs |
| Parts available thru application life | 1-2 year product lifecycle | 5+ year product lifecycle |









Flash Memory Common Design Concerns



GOAL: SOLVE PROBLEMS AND ALLEVIATE CONCERNS





emory The Essence of Value



VALUE

- relative worth, *utility*, or importance

VALUE ADDED

of, relating to, or being a product whose value has been increased especially by special manufacturing, marketing, or processing

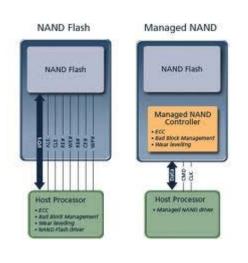




Flash Memory General Value-Add Examples

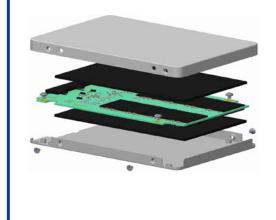
Managed NAND

- Most basic
- Controller manages basic host I/O and NAND flash function



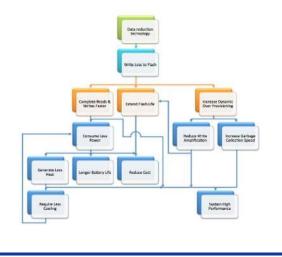
Hardware Features

 Design mods for form-factor, power, security, reliability, environmental, etc.



Software Features

 Firmware mods for endurance, data integrity, performance, compatibility, etc.







Memory Specific Value-Add Technology

| Feature | Benefit | |
|---------------------|---|--|
| Small Designs | Less than half the size of 2.5" SSD/HDD for space-constrained apps | |
| Low Power/Heat | Under 2W for "green" and/or sealed, fan-less systems | |
| Ruggedized | Tolerant to -40C to 85C temps, high humidity, mil-grade shock/vib, etc. | |
| High Reliability | Built-in power-fail protection to protect against unexpected power-loss | |
| Long Endurance | Flash management to extend NAND well beyond mfg stated P/E cycles | |
| Performance | Performance optimized/tuned to host application workload | |
| Workload Monitoring | Provide insight into host data workloads for system/application tuning | |
| Reporting | Real-time health and lifespan monitoring to reduce potential downtime | |
| Security | Built-in levels of data security for select applications | |
| Availability | 5+ year product availability for long-term application deployments | |



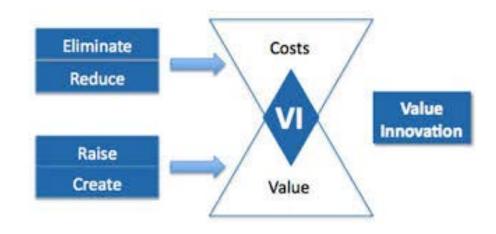


CONCEPT: "Value Innovation"

GOAL: increase value while reducing cost

HOW: focus on solving problems, not just tech

- Cost savings achieved by eliminating or reducing traditional spec-based factors
- Value increased by raising or creating new factors that solve problems and increase utility







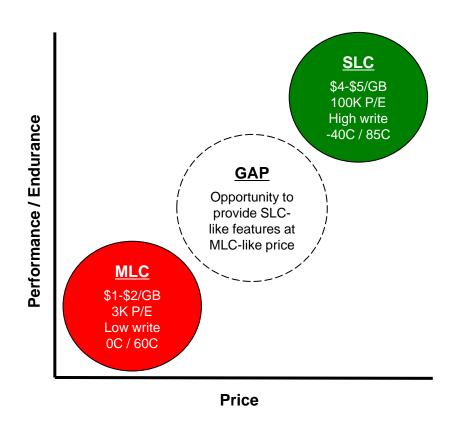
Memory Value Innovation Example

Issue / Problem

- SLC endurance/temp good but \$\$\$ too high
- MLC endurance/temp not sufficient

Value Innovation

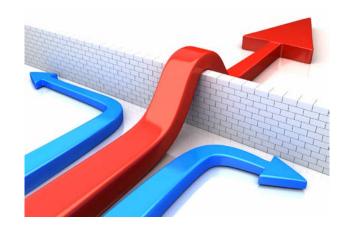
 Offer SLC-like features at MLC-like price







- IoT is a huge and fastgrowing opportunity....but presents challenges
- Standard "off-the-shelf" SSD technology not good enough





Deliver value-add features that solve real-world customer problems, while reducing cost

